

# SPECIFICATION

Device Name : IGBT module

Type Name : IGBT & CNIB-120

Spec. No. : **MS5F3239**

Fuji Electric Co., Ltd.  
Matsumoto Factory

DRAWN	Dec. 3 - '85	S. Miyaguchi	APPROVED	
CHECKED	Dec. 3 '85	T. HOSEKI		
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H04-004-01

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# Revised Records

Date	Classification	Ind.	Content	Applied date	Drawn	Checked	Approved
Dec. 3 '85	enactment	—	—	issued date	—	T. HOSEKI	S. Miyaguchi

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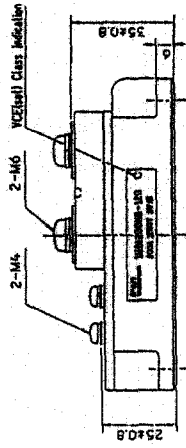
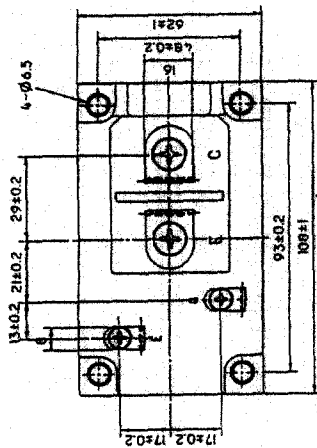
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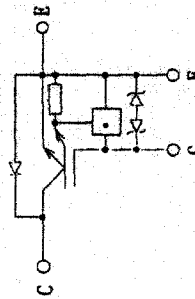
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Ratings and characteristics of Fuji IGBT Module  
1MB1200ND-120

1. Outline Drawing  
Unit : mm



2. Equivalent circuit



\*TRJ (Over Current Limiting Circuit)

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3. Absolute Maximum Ratings ( at Tc=25°C unless otherwise specified )

Items	Symbols	Ratings	Units
Collector-Emitter voltage	V <sub>CE</sub>	1200	V
Gate-Emitter voltage	V <sub>GE</sub>	±20	V
Collector current	IC	200	A
	-IC	400	
Max. power dissipation	PC	1500	W
	TJ	+180	°C
Operating Temperature	Tstg	-40~+125	°C
Storage Temperature	Tstg	AC 2500 (min.)	V
Isolation voltage	Vis	3.5	N·m
Screw torque	Mounting *1	4.5	
	Terminals *2	1.7	
	Terminals *3	1.7	

Note : \*1 Recommendable value : 2.5~3.5 N·m (M6) or (M6)  
 \*2 Recommendable value : 3.5~4.5 N·m (M6)  
 \*3 Recommendable value : 1.3~1.7 N·m (M4)

4. Electrical characteristics ( at Tc=25°C unless otherwise specified )

Items	Symbols	Characteristics		Conditions	Units
		min.	max.		
Zero gate voltage Collector current	I <sub>CS</sub>		4.0	V <sub>GE</sub> =0V, V <sub>CE</sub> =1200V	mA
Gate-Emitter leakage current	I <sub>GES</sub>		60	V <sub>CE</sub> =0V, V <sub>GE</sub> =±20V	μA
Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	4.5	7.5	V <sub>CE</sub> =20V, I <sub>C</sub> =200mA	V
Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>		3.3	V <sub>GE</sub> =16V, I <sub>C</sub> =200A	V
Input capacitance	Cies		32000	V <sub>CE</sub> =0V	pf
Output capacitance	Coes		11800	V <sub>CE</sub> =10V	
Reverse transfer capacitance	Cres		10320	f=1MHz	
Turn-on time	ton	0.66	1.2	V <sub>CE</sub> =600V	μs
Turn-off time	toff	0.25	0.6	I <sub>C</sub> =200A	
Diode forward on voltage	V <sub>F</sub>	0.95	1.5	V <sub>GE</sub> =±15V	
Reverse recovery time	trr	0.35	0.5	I <sub>C</sub> =4.7A	
		3.0	3.0	I <sub>F</sub> =200A, V <sub>GE</sub> =0V	
		350	350	I <sub>F</sub> =200A	

5. Thermal resistance characteristics

Items	Symbols	Characteristics		Conditions	Units
		min.	max.		
Thermal resistance	R <sub>th(j-c)</sub>		0.065	IGBT	°C/W
	R <sub>th(j-e)</sub>		0.22	Diode	
	R <sub>th(c-e)</sub>		0.0125	the base to cooling fin	

\* This is the value which is defined mounting on the additional cooling fin with thermal compound.

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6. VCE(sat) class

Class	VCE(sat) range [V]
F	2.25 ~ 2.5
A	2.4 ~ 2.65
B	2.55 ~ 2.8
C	2.7 ~ 2.95
D	2.85 ~ 3.1
E	3.0 ~ 3.3

7. Indication on module (モジュール表示)



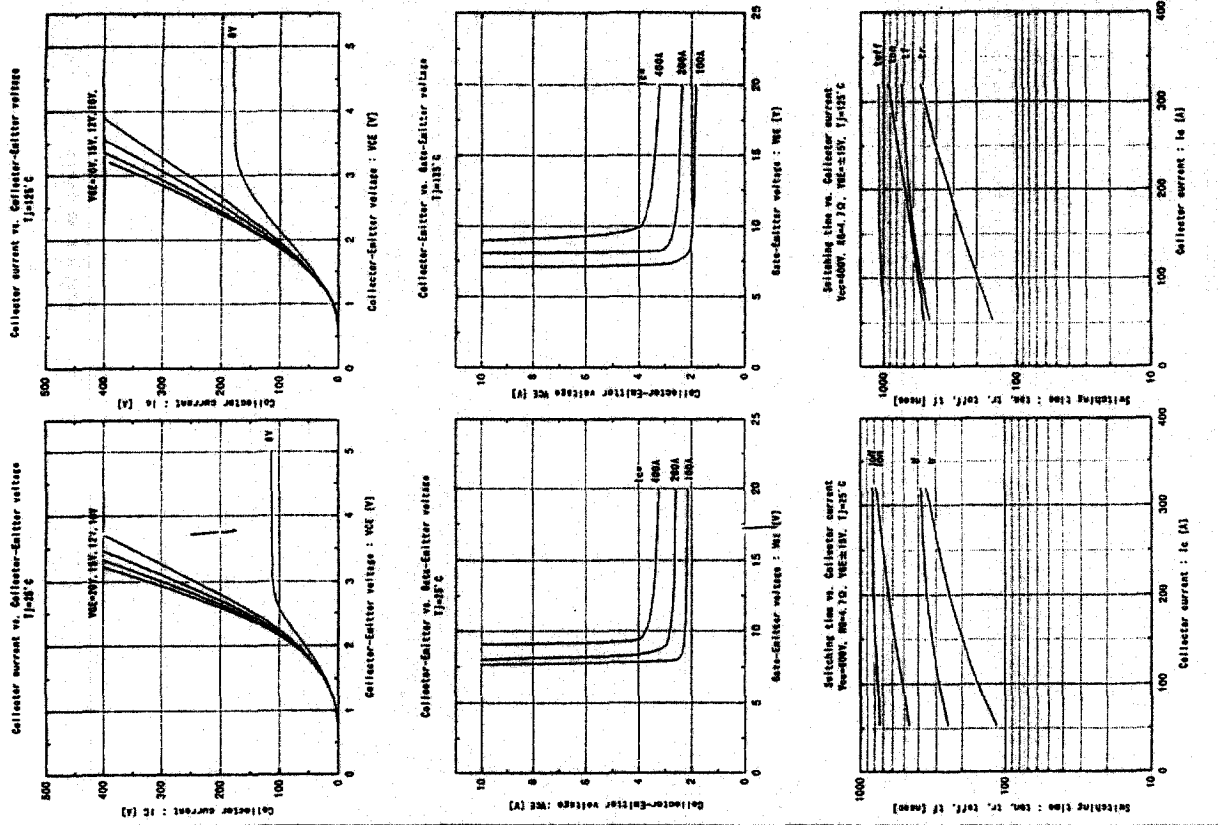
8. Applicable category (適用範囲)

This specification is applied to IGBT module named 1MB1200NB-120.  
 本納入仕様書は、IGBTモジュール1MB1200NB-120に適用する。

9. Storage and transportation notes (保管、運搬上の注意事項)

- The IGBT module should be stored at a standard temperature of 5 to 35°C and humidity of 45 to 75%.  
 常温保存が望ましい。(5~35°C、45~75%)
- Store modules in a place with few temperature changes in order to avoid condensation on the module surface.  
 急激な温度変化の差をここと。(モジュール表面が結露しないこと)
- Avoid exposure to corrosive gases and dust.  
 腐蝕性ガスの発生場所、塵埃の多い場所は避けること。
- Avoid excessive external force on the module.  
 製品に荷重がかからないように十分注意すること。
- Store modules with unprocessed terminals.  
 モジュールの端子は未加工の状態で保管すること。
- Do not drop or otherwise shock the modules when transporting.  
 製品の運搬時に衝撃を与えたり、落下させたりしないこと。

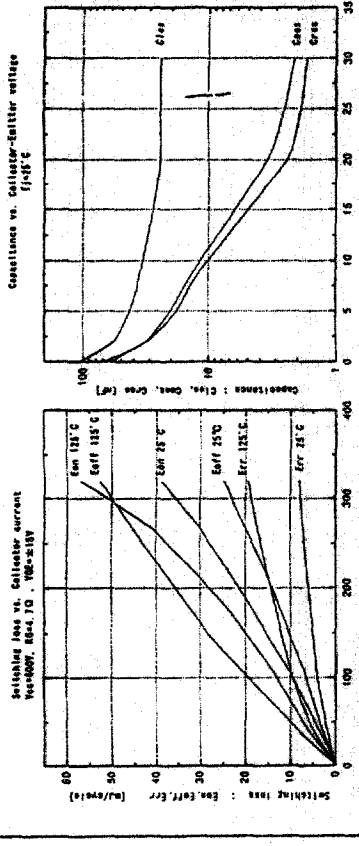
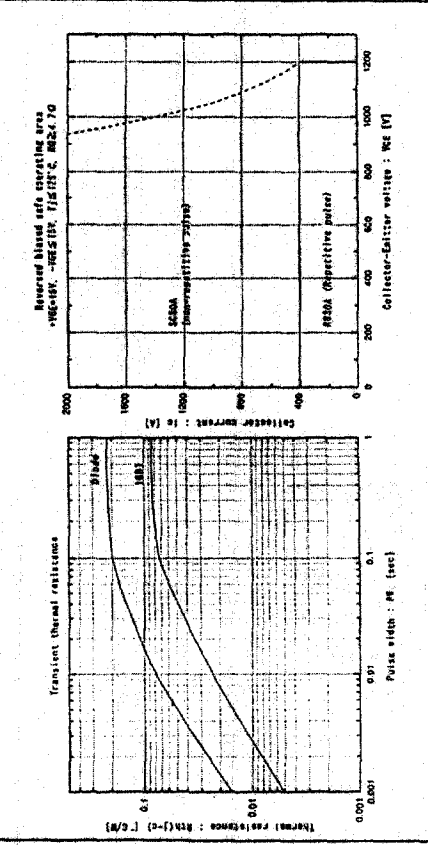
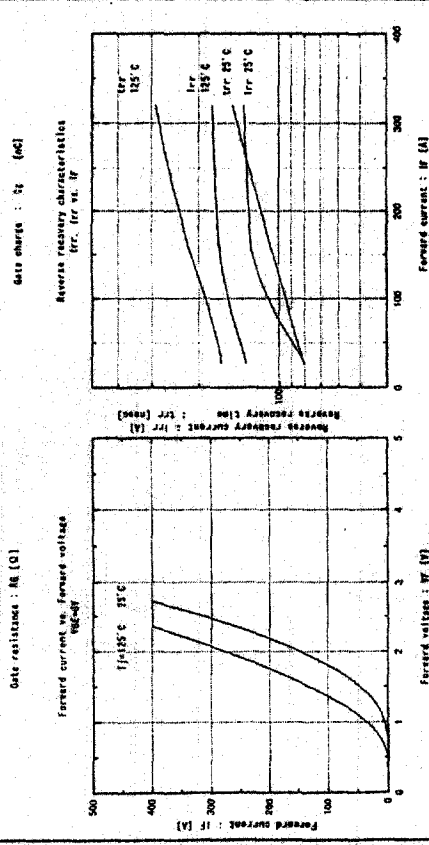
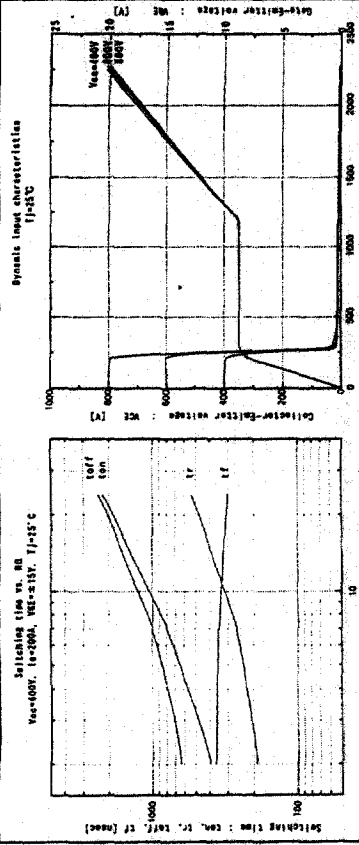
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